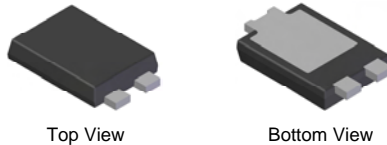


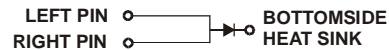
Features

- Lower Forward Voltage Drop than Ultrafast Rectifiers
- Very Low Leakage Current
- Soft Recovery Characteristics: Softness Factor (t_b/t_a) ≥ 1 (see figure 8)
- Highly Stable Oxide Passivated Junction
- High Forward Surge Current Capability
- **Lead Free Finish, RoHS Compliant (Note 1)**
- **"Green" Molding Compound (No Br, Sb)**
- **Qualified to AEC-Q101 Standards for High Reliability**



Mechanical Data

- Case: PowerDI[®]5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Finish – Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (E3)
- Polarity: See Diagram
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.095 grams (approximate)



Note: Pins Left & Right must be electrically connected at the printed circuit board.

Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
 For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}	200	V
Working Peak Reverse Voltage	V_{RWM}		
DC Blocking Voltage	V_R		
RMS Reverse Voltage	$V_{R(RMS)}$	141	V
Average Rectified Output Current (See also figure 5)	I_O	4	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load	I_{FSM}	100	A

Thermal Characteristics

Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance Junction to Soldering Point	$R_{\theta JS}$	—	3.0	$^\circ\text{C/W}$
Thermal Resistance Junction to Ambient Air (Note 2)	$R_{\theta JA}$	80	—	$^\circ\text{C/W}$
Thermal Resistance Junction to Ambient Air (Note 3)	$R_{\theta JA}$	65	—	$^\circ\text{C/W}$
Thermal Resistance Junction to Ambient Air (Note 4)	$R_{\theta JA}$	45	—	$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +175		$^\circ\text{C}$

Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	$V_{(BR)R}$	200	—	—	V	$I_R = 5\mu\text{A}$
Forward Voltage	V_F	—	0.76	0.82	V	$I_F = 3\text{A}, T_S = 25^\circ\text{C}$
		—	—	0.59		$I_F = 3\text{A}, T_S = 150^\circ\text{C}$
		—	0.785	0.84		$I_F = 4\text{A}, T_S = 25^\circ\text{C}$
		—	0.61	0.64		$I_F = 4\text{A}, T_S = 150^\circ\text{C}$
		—	0.84	0.89		$I_F = 8\text{A}, T_S = 25^\circ\text{C}$
		—	0.68	0.75		$I_F = 8\text{A}, T_S = 150^\circ\text{C}$
Reverse Leakage Current (Note 5)	I_R	—	0.2	1	μA mA	$T_S = 25^\circ\text{C}, V_R = 200\text{V}$
		—	0.8	4		$T_S = 150^\circ\text{C}, V_R = 200\text{V}$
Reverse Recovery Time	t_{rr}	—	—	25	ns	$I_F = 0.5\text{A}, I_R = 1.0\text{A}$ $I_{RR} = 0.25\text{A}$ (see Figure 8)

- Notes:
1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see *EU Directive 2002/95/EC Annex Notes*.
 2. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com/datasheets/ap02001.pdf>.
 3. Polyimide PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com/datasheets/ap02001.pdf>.
 4. Polyimide PCB, 2 oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.
 5. Short duration test pulse used to minimize self-heating effect.

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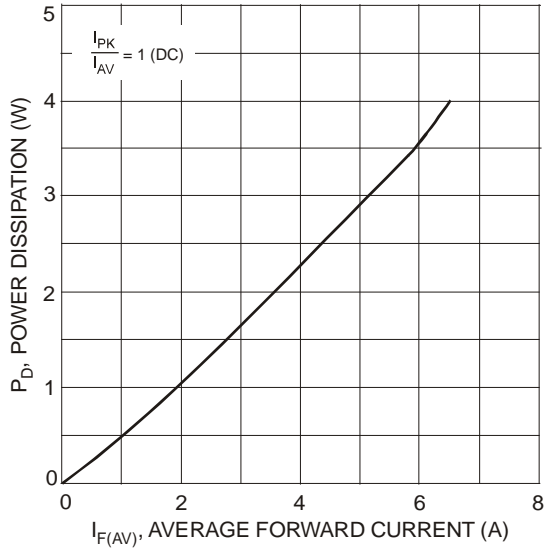


Fig. 1 Forward Power Dissipation

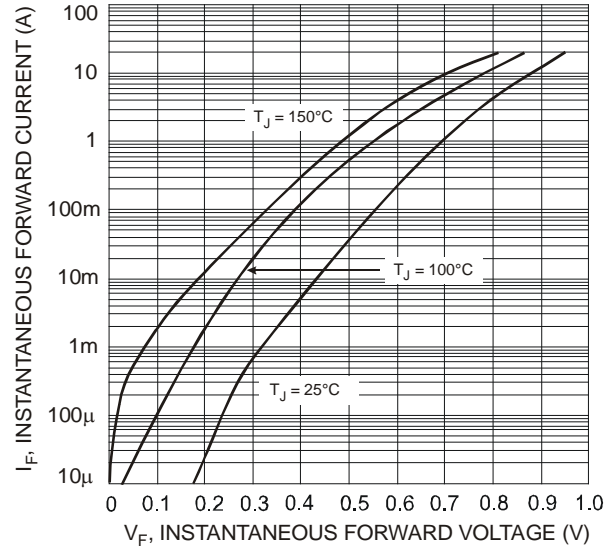


Fig. 2 Typical Forward Characteristics

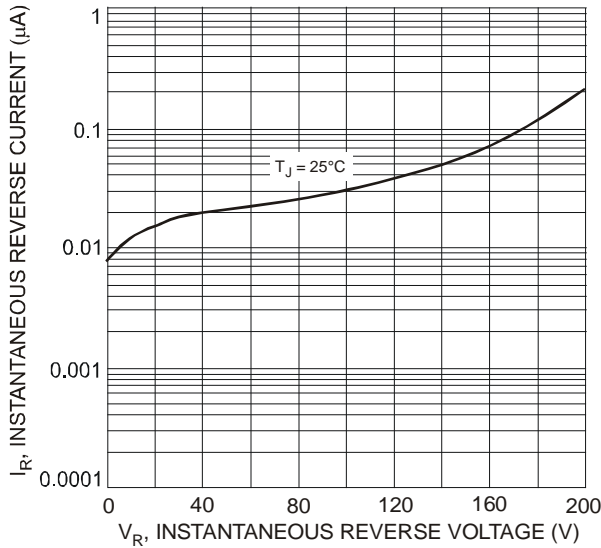


Fig. 3 Typical Reverse Characteristics

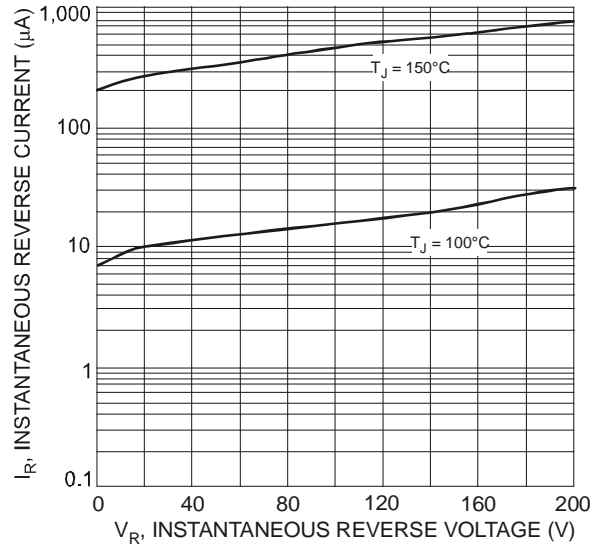


Fig. 4 Typical Reverse Characteristics

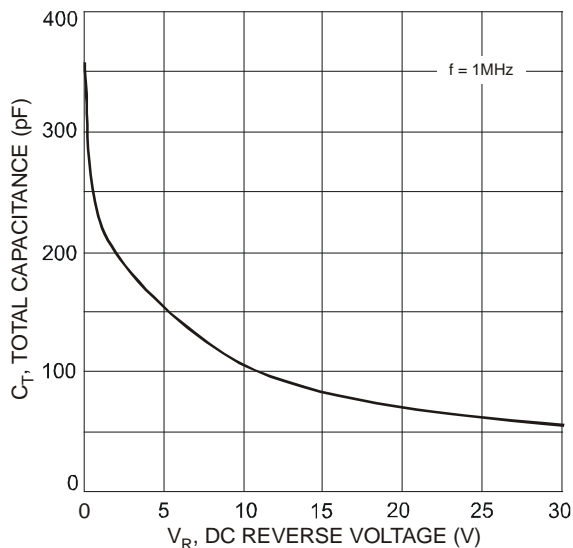


Fig. 5 Total Capacitance vs. Reverse Voltage

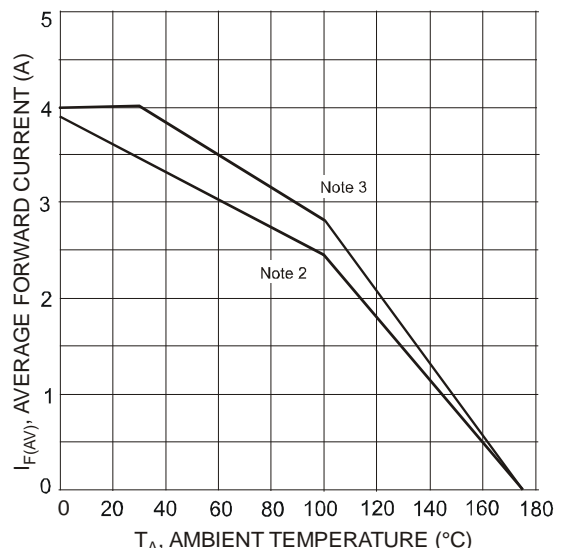


Fig. 6 Forward Current Derating Curve

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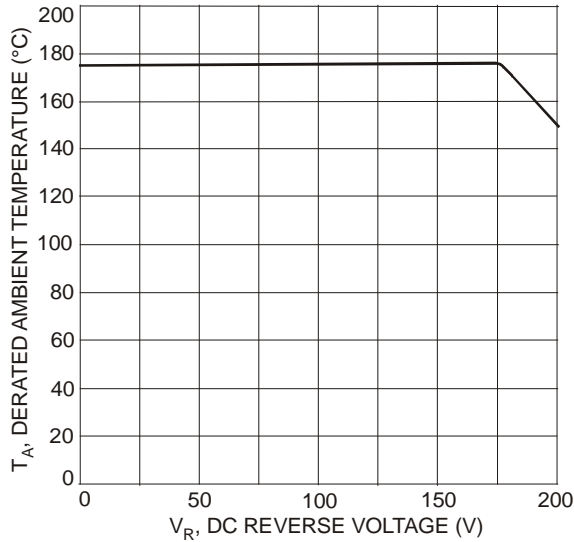


Fig. 7 Operating Temperature Derating

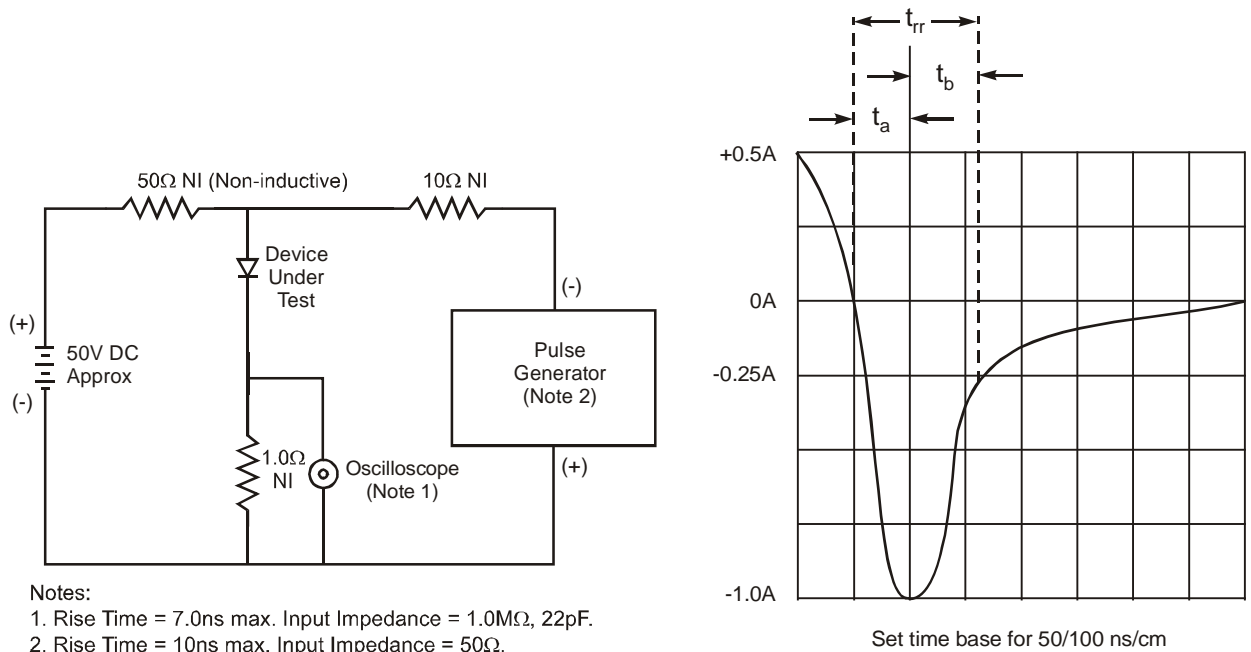


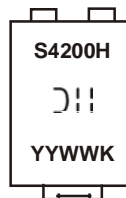
Fig. 8 Reverse Recovery Time Characteristic and Test Circuit

Ordering Information (Note 6)

Part Number	Case	Packaging
PDS4200H-13	PowerDI [®] 5	5000/Tape & Reel

Notes: 6. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

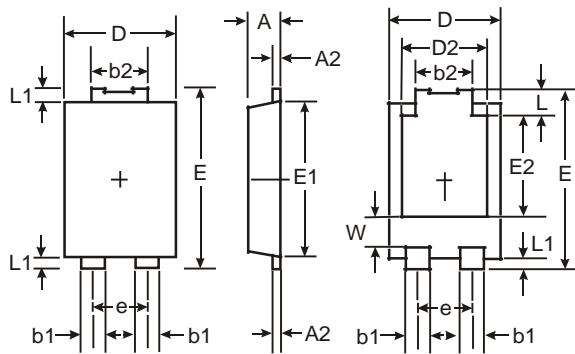
Marking Information



S4200H = Product type marking code
 ⌋⌋ = Manufacturers' code marking
 YYWW = Date code marking
 YY = Last two digits of year ex: 06 for 2006
 WW = Week code 01 to 52
 K = Factory Designator

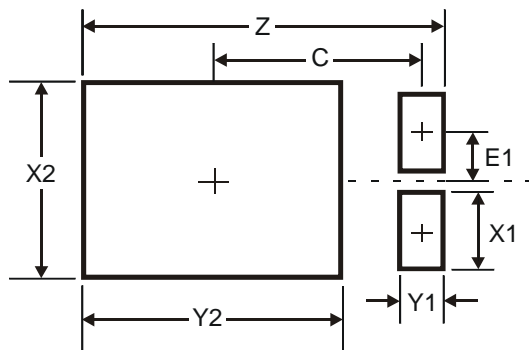
PowerDI is a registered trademark of Diodes Incorporated.

Package Outline Dimensions



PowerDI ^{®5}		
Dim	Min	Max
A	1.05	1.15
A2	0.33	0.43
b1	0.80	0.99
b2	1.70	1.88
D	3.90	4.05
D2	3.05 NOM	
E	6.40	6.60
e	1.84 NOM	
E1	5.30	5.45
E2	3.55 NOM	
L	0.75	0.95
L1	0.50	0.65
W	1.20	1.50
All Dimensions in mm		

Suggested Pad Layout



Dimensions	Value (in mm)
Z	6.6
X1	1.4
X2	3.6
Y1	0.8
Y2	4.7
C	3.87
E1	0.9

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